

Vishay General Semiconductor

COMPLIANT

HALOGEN

**FREE** 

## **Surface-Mount Fast Switching Rectifiers**

# eSMP® Series



**SMF (DO-219AB)** 

Cathode O Anode

### **LINKS TO ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	1 A				
$V_{RRM}$	200 V, 400 V, 600 V, 800 V, 1000 V				
I <sub>FSM</sub>	35 A				
I <sub>R</sub>	0.2 μΑ				
$V_F$ at $I_F = 1$ A	0.84 V				
T <sub>J</sub> max.	150 °C				
Package	SMF (DO-219AB)				
Circuit configuration	Single				

#### **FEATURES**

- Glass passivated pellet chip junction
- Ideal for automated placement
- Meets MSL level 1, per J-STD-020; LF maximum peak of 260 °C
- Wave and reflow solderable
- Compatible to SOD-123W package case outline
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

### **TYPICAL APPLICATIONS**

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, and telecommunication.

#### **MECHANICAL DATA**

Case: SMF (DO-219AB)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	RS1FLD	RS1FLG	RS1FLJ	RS1FLK	RS1FLM	UNIT
Device marking code		RLD	RLG	RLJ	RLK	RLM	
Max. repetitive peak reverse voltage	$V_{RRM}$	200	400	600	800	1000	V
Max. DC forward current (see fig. 1)	I <sub>F</sub> <sup>(1)</sup>	1			Α		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	35			Α		
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150			°C		

#### Note

(1) Free air, mounted on recommended PCB, 2 oz. pad area



www.vishay.com

## Vishay General Semiconductor

<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	I <sub>F</sub> = 1.0 A	T <sub>J</sub> = 25 °C		0.96	1.2	V	
		T <sub>J</sub> = 125 °C	V <sub>F</sub> <sup>(1)</sup>	0.84	1.1		
	I <sub>F</sub> = 2.0 A	T <sub>J</sub> = 25 °C		1.04	-		
		T <sub>J</sub> = 125 °C		0.93	-		
Reverse current	Rated V <sub>R</sub>	T <sub>J</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	0.2	5.0	μА	
		T <sub>J</sub> = 125 °C	IR (=/	20	200		
Typical reverse recovery time	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1.0 A, I <sub>rr</sub> = 0.25 A		t <sub>rr</sub>	-	500	ns	
Typical junction capacitance	4.0 V, 1 MHz		CJ	7	-	pF	

#### Notes

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °c unless otherwise noted)							
PARAMETER	SYMBOL	RS1FLD	RS1FLG	RS1FLJ	RS1FLK	RS1FLM	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)(2)}$			130			°C/W
Typical trieffial resistance	R <sub>0JM</sub> (1)	20				C/VV	

### Notes

(1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction-to-ambient;  $R_{\theta JM}$  - junction-to-mount

 $<sup>^{(2)}</sup>$  The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ 

ORDERING INFORMATION (Example)							
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE			
RS1FLM-M3/H	0.0145	Н	3000	7" diameter plastic tape and reel			
RS1FLM-M3/I	0.0145	I	10 000	13" diameter plastic tape and reel			

## Vishay General Semiconductor

### **RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25$ °C unless otherwise noted)

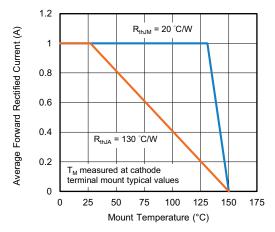


Fig. 1 - Max. Forward Current Derating Curve

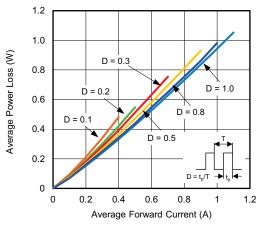


Fig. 2 - Forward Power Loss Characteristics

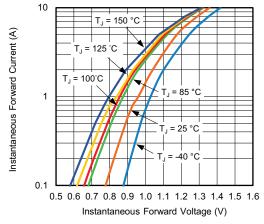


Fig. 3 - Typical Instantaneous Forward Characteristics

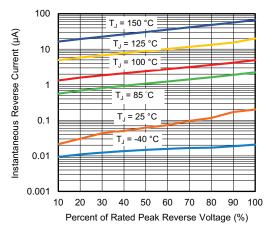


Fig. 4 - Typical Reverse Characteristics

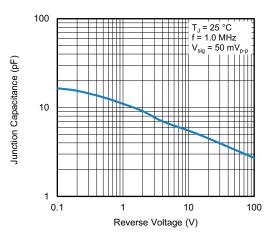


Fig. 5 - Typical Junction Capacitance

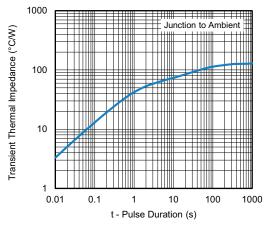
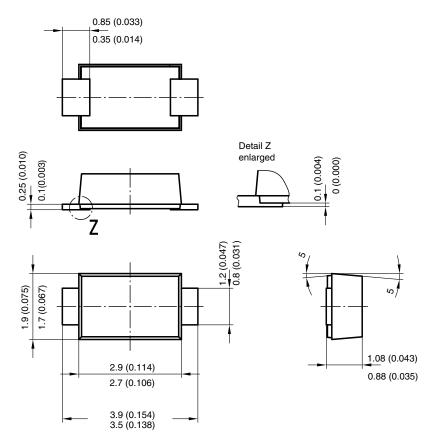


Fig. 6 - Typical Transient Thermal Impedance

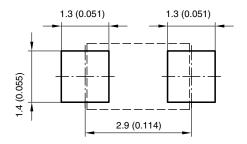
Vishay General Semiconductor

### **PACKAGE OUTLINE DIMENSIONS** in millimeters (inches)

www.vishay.com



Foot print recommendation:



Created - Date: 15. February 2005 Rev. 3 - Date: 13. March 2007 Document no.: S8-V-3915.01-001 (4) 17247



## **Legal Disclaimer Notice**

Vishay

### **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.